



2nd Generation 3D Hall Sensors

ATV Sense & Control
January 20

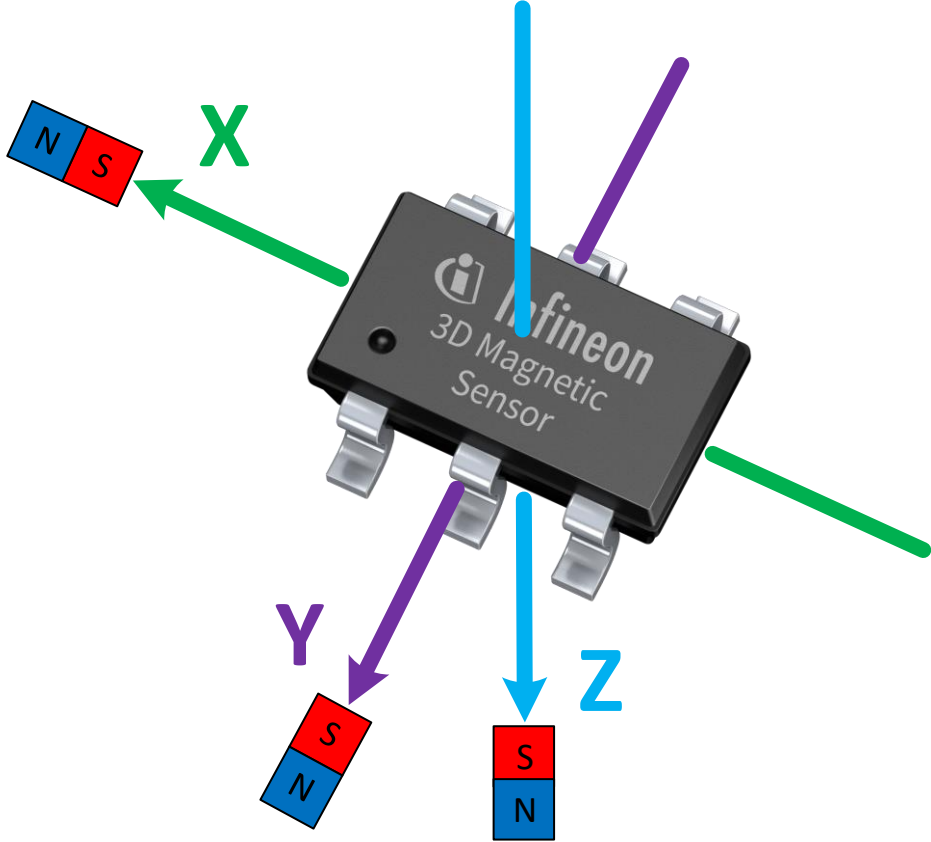


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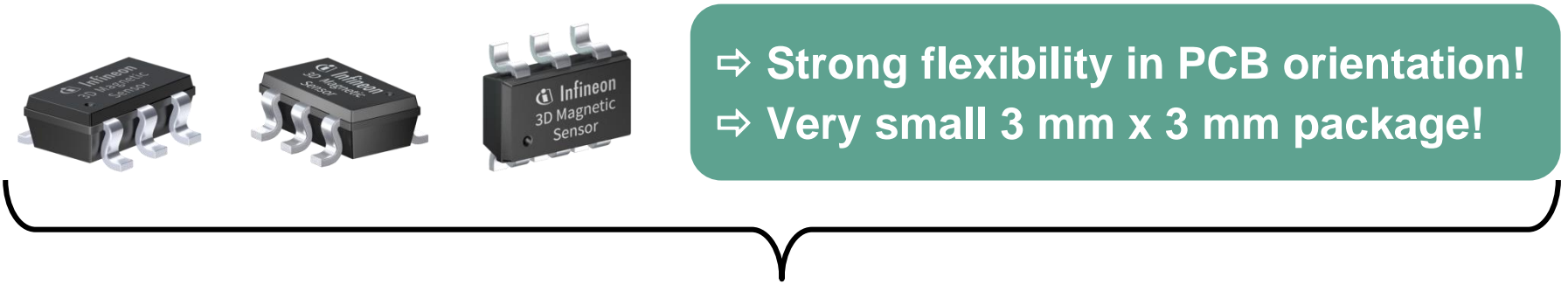
Table of contents

1	3D Hall sensor product concept	2
2	Portfolio and key features	7
3	Improvements of the 2nd generation	13

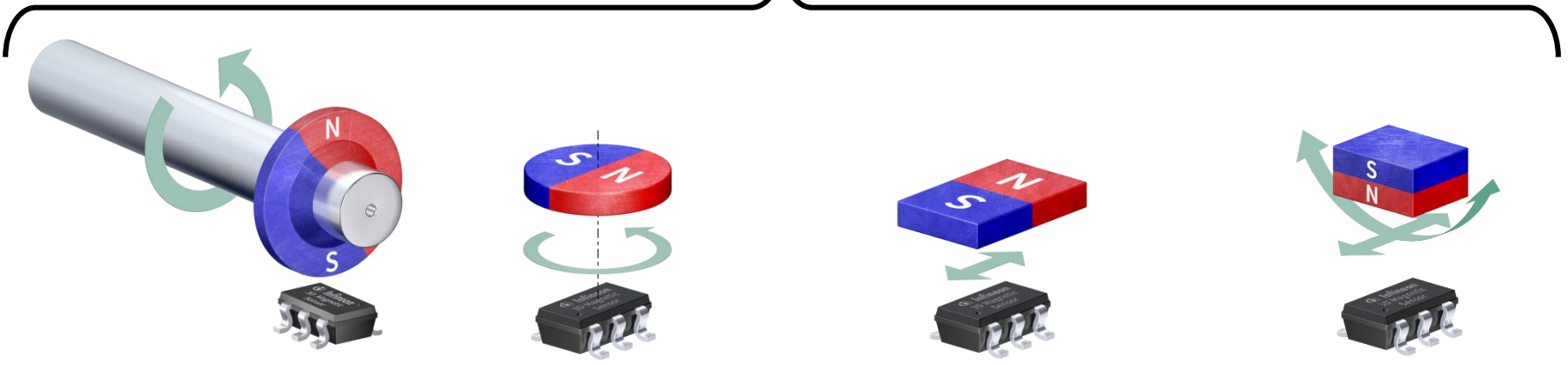
Magnetic field measurement in three dimensions



3DHall benefits



Supporting the applications



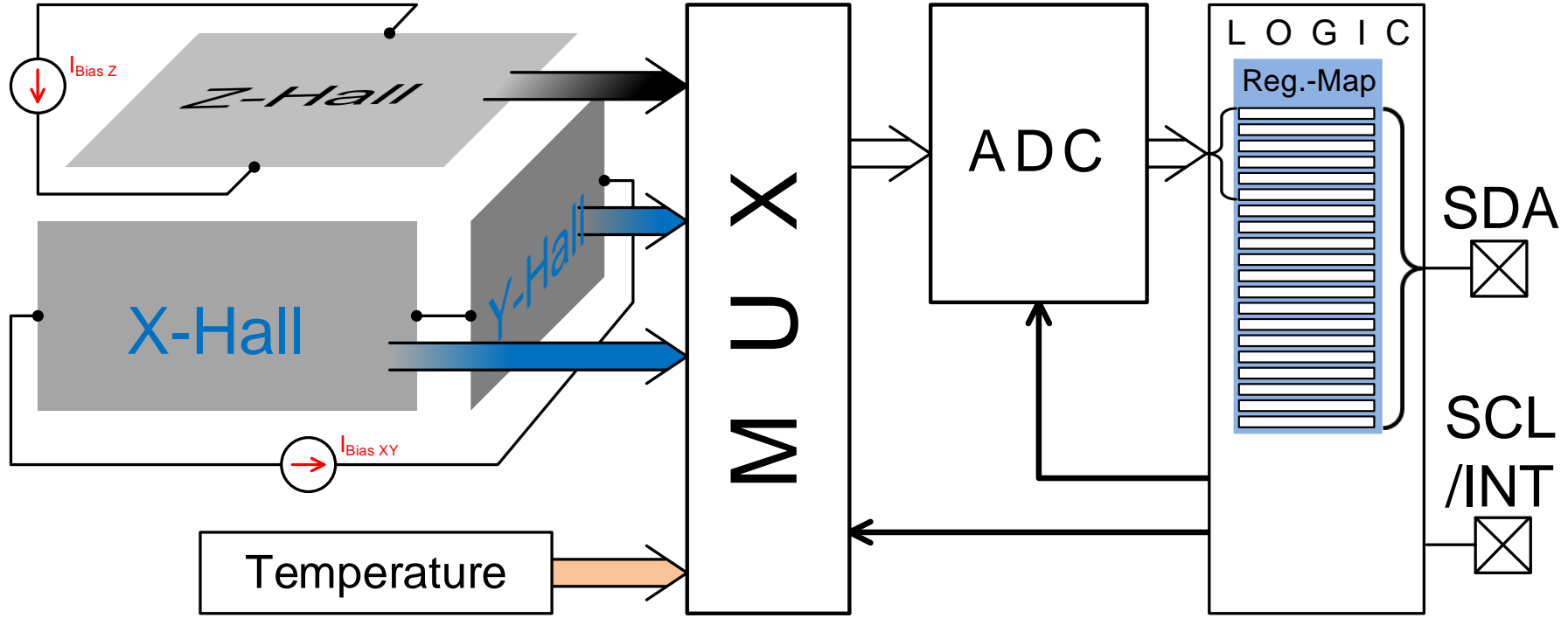
Out of shaft angle measurement

End of shaft angle measurement

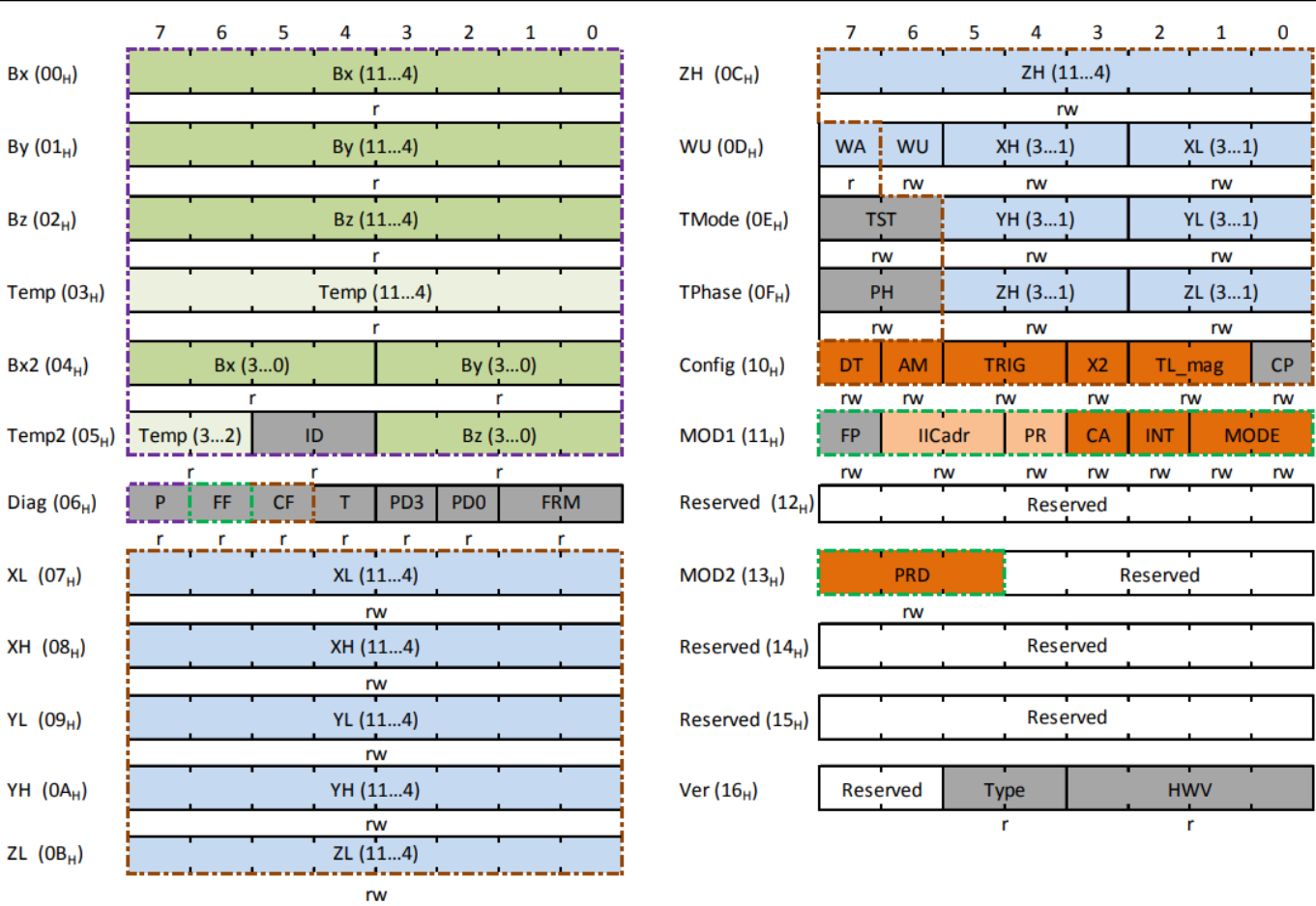
Linear movement measurement

Joystick movement measurement

The 3D Hall block schematic



Bitmap example: TLE493D-W2B6



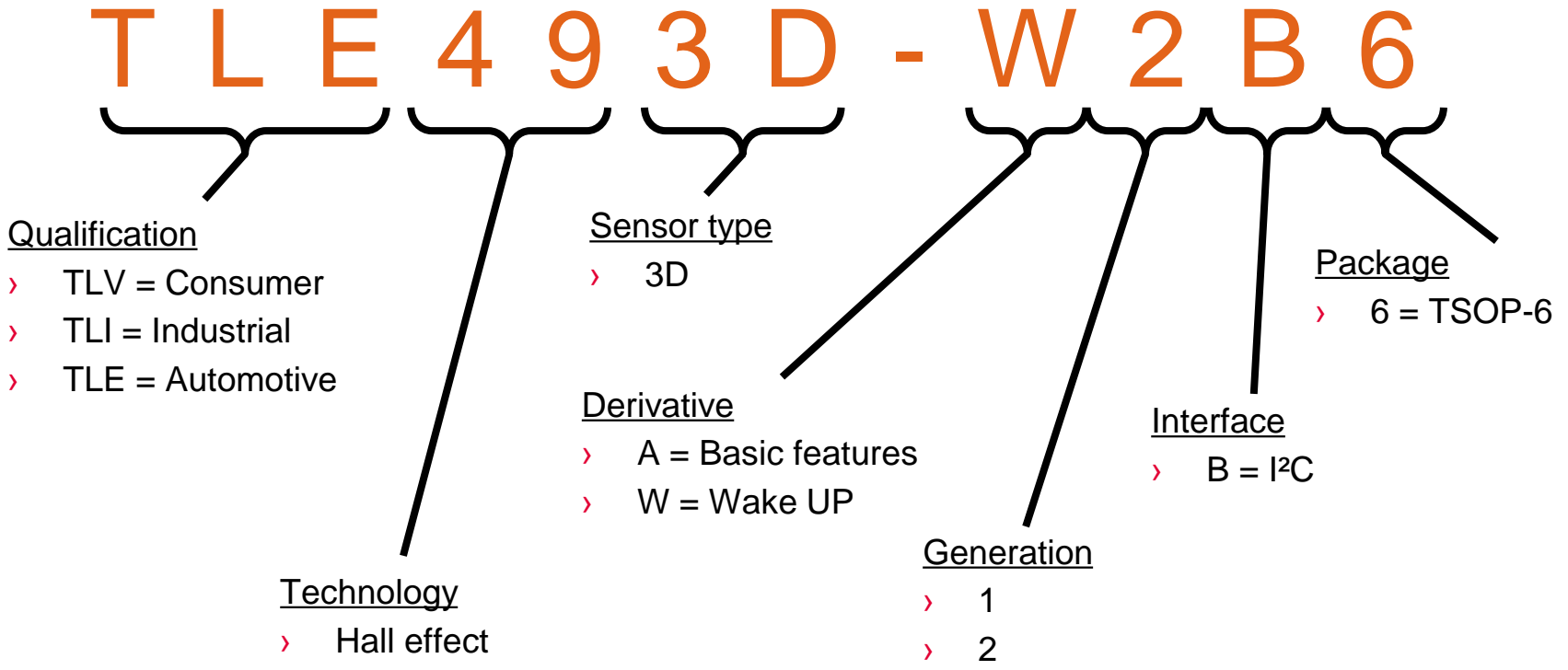
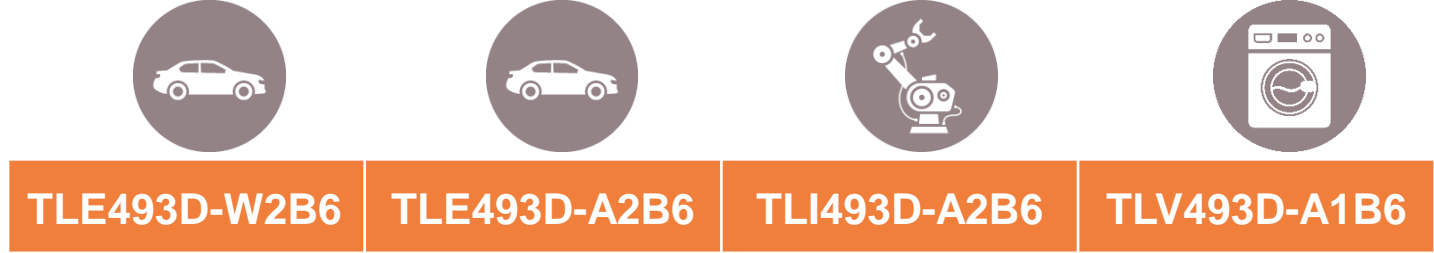
Colour legend for the Bitmap

- Magnetic values
- Temperature values
- Configuration
- Configuration bus
- Diagnosis
- Reserved bits
- Wake Up
- Parity bits and related registers (colour)





Table of contents

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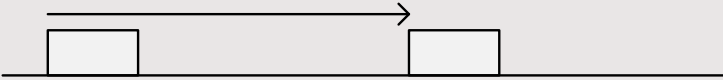


The 3D Hall sensor family



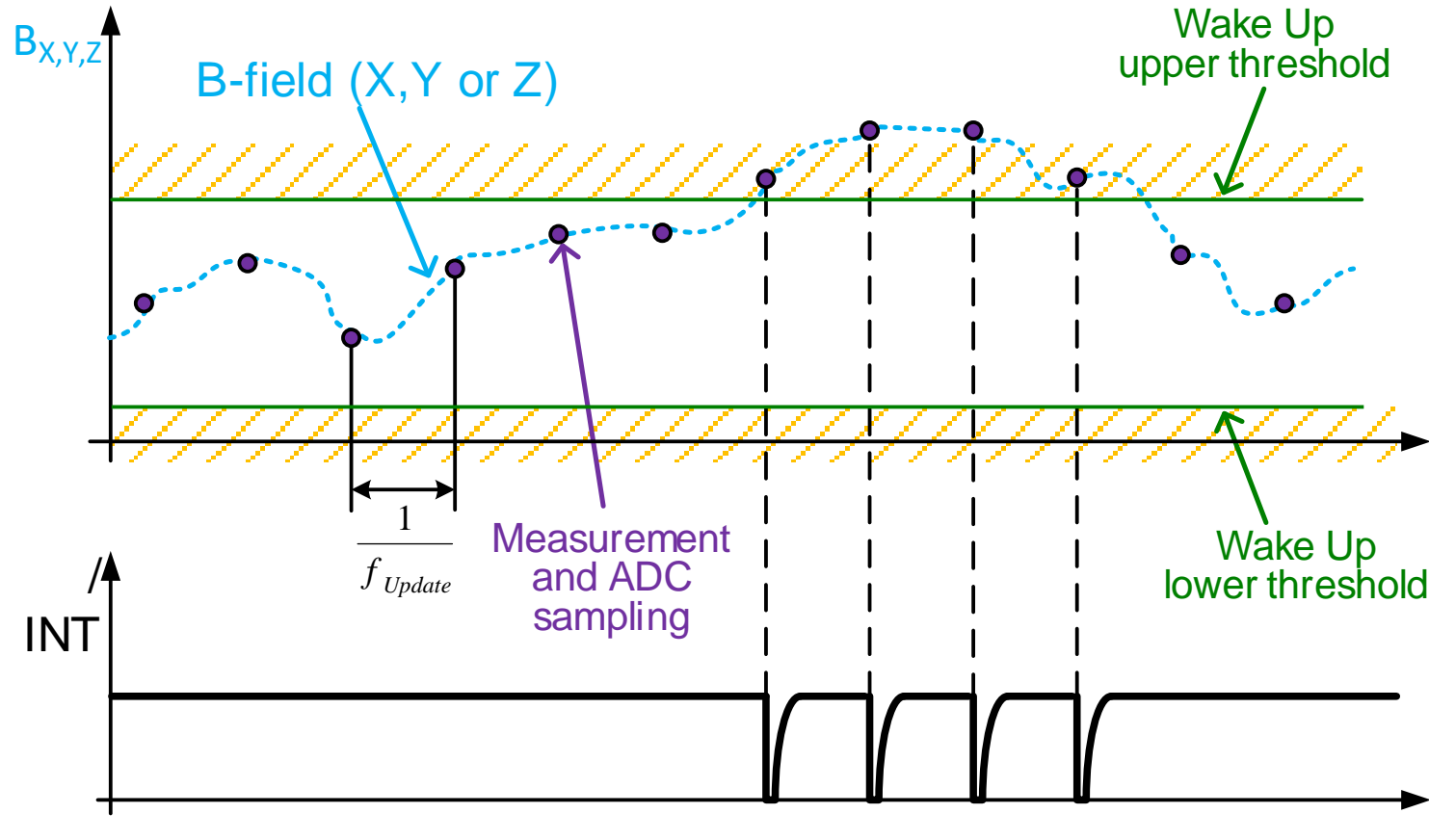
The 3D Hall sensor family

	 TLE493D-W2B6	 TLE493D-A2B6	 TLI493D-A2B6	 TLV493D-A1B6
Generation	2nd			1st
Temperature range	-40...125°C		-40...105°C	-40...125°C
Linear magnetic field range	selectable: min. 100 and 160 mT			typ. 130 mT
Magnetic accuracy	high (min./max. spec.)			basic (typ. spec.)
Update rate XYZ	typ. 7.5 kHz			typ. 3.3 kHz
Functional safety	ASIL B (ISO26262 ready)	-		
Wake up mode	Yes	-		
Preconfigured address variants	4 (A0 ... A3)		1	

Different power modes for a high flexibility (2nd generation 3D Hall)

Modes	Measurements	Typ. current consumption
Power down	No measurements: ADC: _____	7 nA
Low power	Cyclic measurements with a selectable update rate between 0.05 and 700 Hz: ADC: 	0.3 μ A...430 μ A
Fast	Continuous measurements: ADC: 	3.4 mA
Master controlled	Measurements triggered by the microcontroller via I ² C: ADC: 	Between power down and fast mode

Power saving using the Wake-Up feature (TLE493D-W2B6)



Bus mode for multiple 3D Hall sensors

- › 4 preconfigured address variants allow an out of the box bus mode
 - ➔ TLE493D-W2B6 only
- › Alternative for all 3D Hall sensors:
 - Control the VDD of all sensors but the first with a GPIO pin
 - Reconfigure the I2C address at startup
- › For functional safety critical applications a separate bus for each sensor is recommended

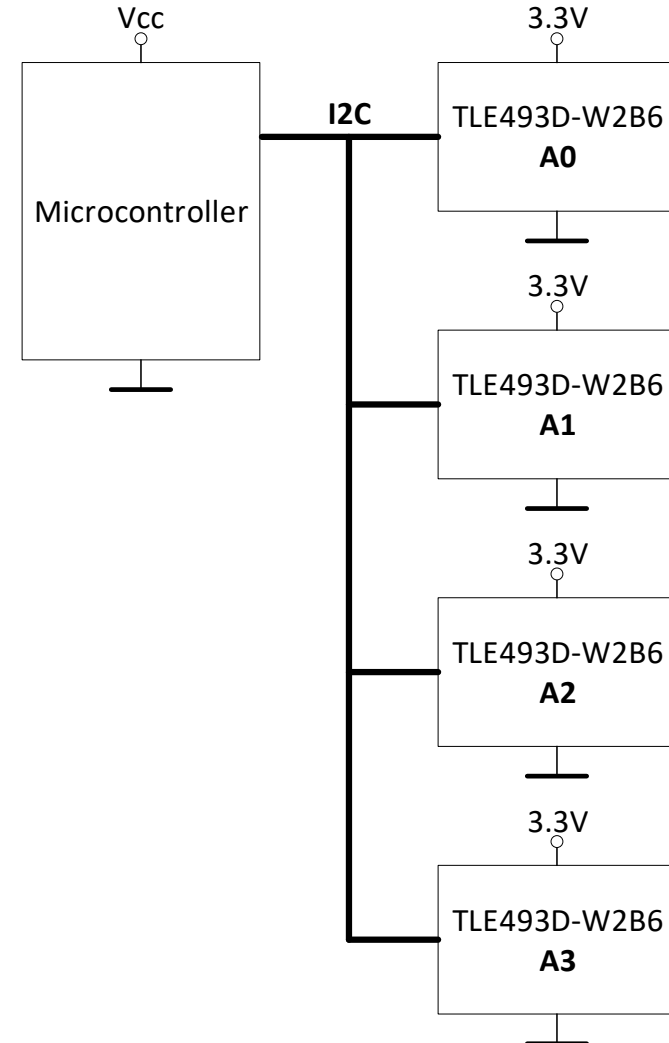


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Improvements of the 2nd generation 3D Hall sensors

Topic	Description
Higher reliability	<ul style="list-style-type: none"> › Designed to meet the automotive quality standards › Min / max datasheet specifications › Improved power on reset › Improved ADC stability in fast and master controlled mode › Removed dynamic I²C address setting at power-up
Higher performance	<ul style="list-style-type: none"> › Increased sensitivity (two magnetic field ranges) › Higher update rate › Generally higher accuracy
New features	<ul style="list-style-type: none"> › Improved master controlled mode: <ul style="list-style-type: none"> – Flexible new ADC trigger options – Automated power down after a finished measurement cycle › I²C clock stretching › /INT collision avoidance › Advanced features with the TLE493D-W2B6 variant: <ul style="list-style-type: none"> – Wake up mode – Dedicated I²C address variants – Functional safety support – Additional low power modes



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Disclaimer

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